

# **Description**

The VSM3415 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as1.8V. This device is suitable for use as a load switch or in PWM applications .It is ESD protested.

#### **General Features**

•  $V_{DS} = -20V, I_{D} = -4A$ 

 $R_{DS(ON)}$  < 36m $\Omega$  @  $V_{GS}$ =-4.5V

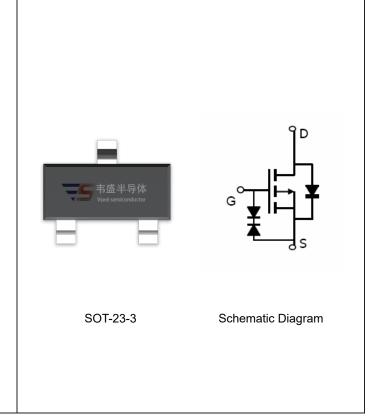
 $R_{DS(ON)}$  < 49m $\Omega$  @  $V_{GS}$ =-2.5V

ESD Rating: 2500V HBM

- High Power and current handing capability
- Lead free product is acquired
- Surface mount package

## **Application**

- PWM application
- Load switch



#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM3415-S2	VSM3415	SOT-23-3	Ø180mm	8 mm	3000 units

## Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	-20	V	
Gate-Source Voltage	Vgs	±10	V	
Drain Current-Continuous	I <sub>D</sub>	-4	Α	
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	-30	Α	
Maximum Power Dissipation	P <sub>D</sub>	1.4	W	
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 150	$^{\circ}\mathbb{C}$	

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	R <sub>0JA</sub>	89.3	°C/W
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### Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-20		-	V



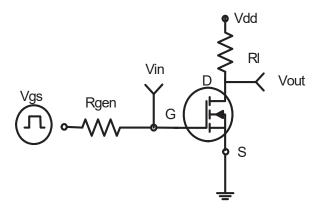
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±10	μA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-0.35	-0.65	-0.9	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A	-	29	36	mΩ
Diam-Source On-State Resistance		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-4A	-	37	49	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-4A	8	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ - 10\/\/ -0\/	-	1181.1	-	PF
Output Capacitance	Coss	$V_{DS}$ =-10V, $V_{GS}$ =0V, F=1.0MHz	-	121.3	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F-1.0IVID2	-	114.8	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	12		nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-10V,R <sub>L</sub> =2. 5 $\Omega$	-	10		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-4.5 $V$ , $R_{GEN}$ =3 $\Omega$	-	19		nS
Turn-Off Fall Time	t <sub>f</sub>		-	25		nS
Total Gate Charge	Qg	\/ - 10\/   - 10	-	10.2		nC
Gate-Source Charge	$Q_{gs}$	$V_{DS}$ =-10V, $I_{D}$ =-4A, $V_{GS}$ =-4.5V	-	1.3	-	nC
Gate-Drain Charge	$Q_{gd}$	V GS4.0 V	-	2.4	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-4A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-4	Α
	•	•				

## Notes:

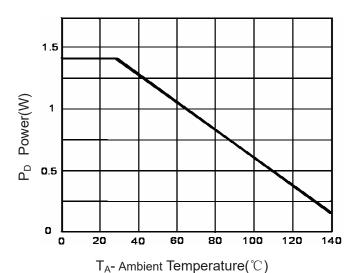
- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature}.$
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production



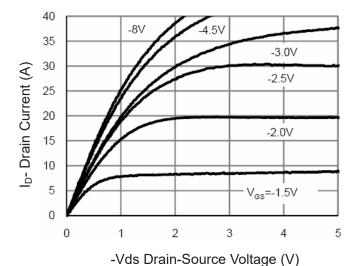
# **Typical Electrical and Thermal Characteristics**



**Figure 1:Switching Test Circuit** 



**Figure 3 Power Dissipation** 



**Figure 5 Output Characteristics** 

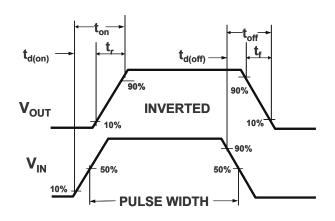


Figure 2:Switching Waveforms

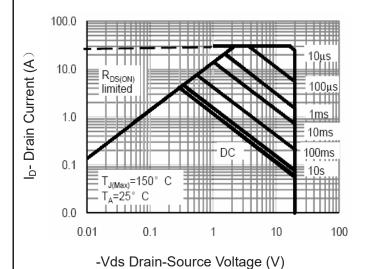


Figure 4 Safe Operation Area

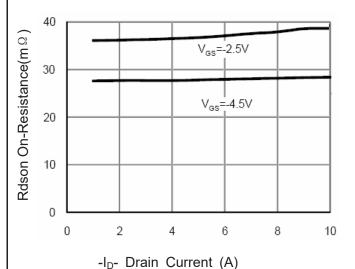


Figure 6 Drain-Source On-Resistance



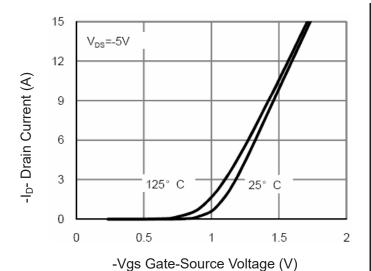
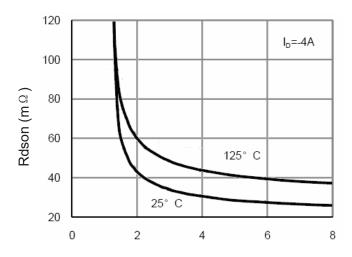


Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)
Figure 9 Rdson vs Vgs

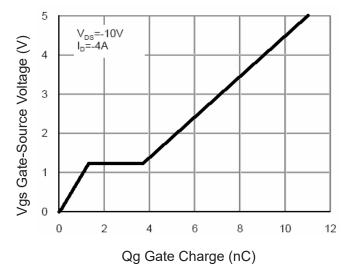


Figure 11 Gate Charge

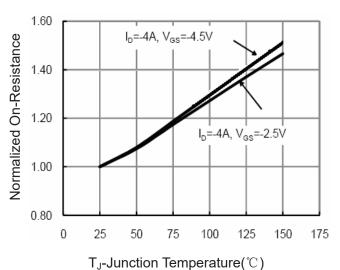
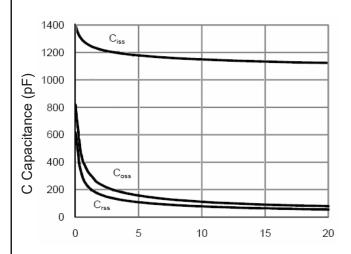


Figure 8 Drain-Source On-Resistance



Vds Drain-Source Voltage (V)

Figure 10 Capacitance vs Vds

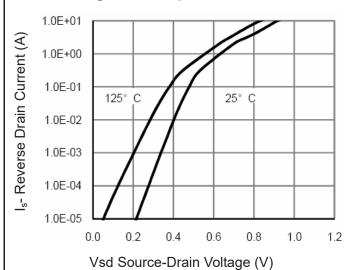
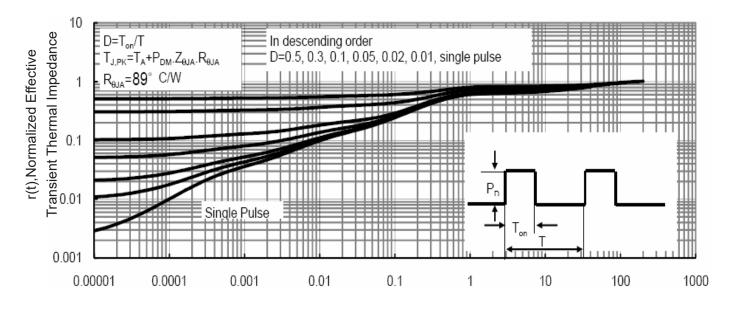


Figure 12 Source- Drain Diode Forward





Square Wave Pluse Duration(sec)

Figure 13 Normalized Maximum Transient Thermal Impedance